

Performance Enhancement of MoS₂ Field Effect Transistors with Silver Contacts

Hui Yuan^{a,b}, Guangjun Cheng^a, Lin You^a, Haitao Li^{a,b}, Hao Zhu^{a,b}, Wei Li^a, Yaw S. Obeng^a, Joseph J. Kopanski^a, Angela R. Hight Walker^a, David Gundlach^a, Curt A. Richter^a, Dimitris E. Ioannou^{a,b} and Qiliang Li^{a,b}

^a Semiconductor and Dimensional Metrology Division, National Institute of Standards and Technology, Gaithersburg, MD, USA (hyuan@gmu.edu), ^b Department of Electrical and Computer Engineering, George Mason University, Fairfax, VA, USA. (qli6@gmu.edu)

The success of graphene has led to an explosion of new research into two-dimensional (2D) electronic materials [1]. Compared with bulk semiconductors, 2D materials have better electrostatic control and are expected to improve short-channel effects during aggressive CMOS scaling. Recently, transition-metal dichalcogenides (TMDs), such as MoS₂ and WSe₂, have attracted much attention. Generally, these 2D materials have a layered structure coupled by van der Waals interactions and can be exfoliated from bulk crystals [2]. MoS₂ thin films have desirable bandgaps (E_g) ranging from 1.2eV to 1.8eV depending on the number of layers [3]. MoS₂ monolayers have a direct bandgap of 1.8eV and are, therefore, attractive for optoelectronic applications. After the demonstration of single-layer MoS₂ transistors with a high ON/OFF ratio and acceptable subthreshold slope [4], optoelectronic applications such as photoluminescence [5], electric luminescence [6] and photo detecting [7], have been reported. To achieve better device performance, high-quality metal contacts on MoS₂ are required. However, the study of metal contact effects is difficult because the relationship of the bulk metal work function to that of MoS₂ simply fails to explain the abnormal I-V behavior in MoS₂ transistors. [8]

This work presents the results of our recent attempts to enhance MoS₂ FET performance by selecting proper contact materials and insights into the contact mechanism obtained from scanning electron microscopy (SEM) and Raman spectroscopy. Devices were fabricated from exfoliated single and few layer MoS₂. Metal contacts to the MoS₂ were patterned by e-beam lithography, metal evaporation, and lift off techniques. The channel length of all devices is 1 μm (Fig. 1a). Either 30 nm Ag or 30nm Ti were deposited for this comparison, capped with 30 nm Au to ensure good electrical contact. I_D - V_D characterization reveals that by replacing commonly used Ti contacts with Ag as the contact to single layer MoS₂ back-gated FETs a sharper switching between ON and OFF states is obtained and the ON-state current is enhanced by more than 60 times (Fig. 1b - 1d).

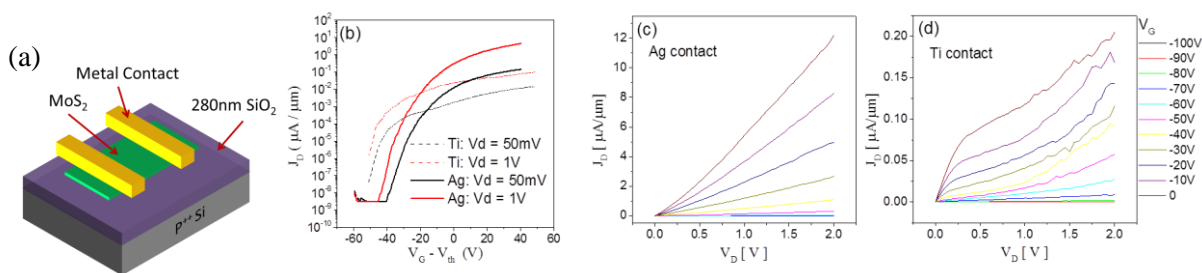


Fig. 1: (a) MoS₂ FET schematic. (b) Drain current normalized to unit channel width versus $V_G - V_{th}$ with different drain voltage in single layer MoS₂ devices with Ag or Ti contact. (c,d) Drain current normalized to unit channel width versus drain voltage in single layer MoS₂ devices with (c) Ag or (d) Ti contact. Note the current amplitudes in (c) and (d).

To study the mechanism of current enhancement, we deposited thin metals, either 5 nm Ag or 5 nm Ti covered by 5 nm Au on exfoliated MoS₂. SEM was then carried out to show the morphology of these deposited thin films. SEM shows that relatively smooth Au/Ag films form on top of MoS₂ (Fig. 3(a)) despite the varied morphology of metal clusters that form when these metals are directly deposited on the SiO₂/Si substrate. These smooth Ag films are in contrast to Au/Ti films that are equally rough on both the MoS₂ films and the SiO₂/Si substrate (Fig. 3(b)). This difference indicates that the interaction

between Ag and MoS₂ is different from the interaction between Ti and MoS₂. A more efficient carrier transport is expected from the smoother Ag contact.

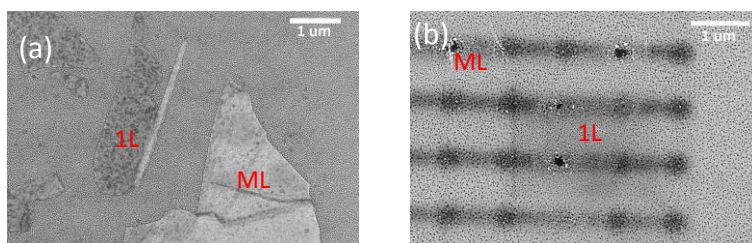


Fig. 2: SEM image after (a) Au/Ag deposition or (b) Au/Ti deposition

Raman spectroscopy performed before and after metal deposition in ambient conditions with a 514.5 nm excitation laser reveals changes. Preliminary analysis reveals different peak shifting and broadening for the two metals (Fig. 2). Similar Raman behavior was also seen in few-layer MoS₂. Further analysis is underway to fully understand these changes.

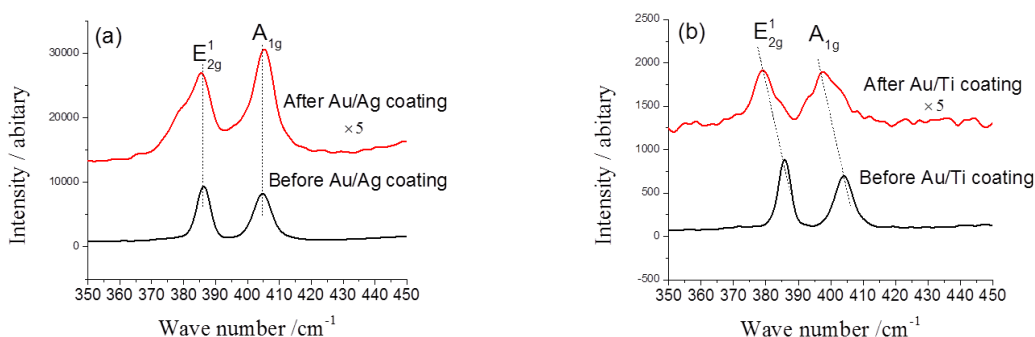


Fig. 3: Comparison of Raman spectroscopy before and after (a) Au/Ag deposition or (b) Au/Ti deposition

In conclusion, a smooth Ag film formed on top of MoS₂ results in more efficient carrier injection from Ag contacts compared to Ti which has a rough surface when deposited on MoS₂. As a result, current enhancement and better electrostatics are realized with Ag contacts.

References

- [1] K. S. Novoselov, A. K. Geim, S. V. Morozov, D. Jiang, Y. Zhang, S. V. Dubonos, I. V. Grigorierva, A. A. Firsov, "Electric Field Effect in Atomically Thin Carbon Films," *Science*, vol. 306, no. 5696, pp. 666(4), October 2004.
- [2] H. Li, Q. Zhang, C. C. R. Yap, B. K. Tay, T. H. T. Edwin, A. Olivier, D. Baillargeat, "From Bulk to Monolayer MoS₂: Evolution of Raman Scattering," *Adv. Funct. Mater.*, vol. 22, no. 7, pp. 1385(6), April 2012.
- [3] S. Lebegue, O. Eriksson, "Electronic Structure of Two-dimensional Crystals from ab initio Theory," *Phys. Rev. B*, vol. 79, no. 11, pp. 115409(4), March 2009.
- [4] B. Radisavljevic, A. Radenovic, J. Brivio, V. Giacometti, A. Kis, "Single-layer MoS₂ transistors," *Nat. Nano.*, vol. 6, no. 3, pp. 147(4), March 2011.
- [5] A. Splendiani, L. Sun, Y. Zhong, T. Li, J. Kim, C. Y. Chim, G. Galli, F. Wang, "Emerging Photoluminescence in Monolayer MoS₂," *Nano. Lett.*, vol. 10, no. 4, pp. 1271(5), March 2010.
- [6] R. S. Sundaaram, M. Engel, A. Lombardo, R. Krupke, A. C. Ferrari, Ph. Avouris, M. Steiner, "Electroluminescence in Single Layer MoS₂," *Nano. Lett.*, vol. 13, no. 4, pp. 1416(6), March 2013.
- [7] Z. Yin, H. Li, H. Li, L. Jiang, Y. Shi, Y. Sun, G. Lu, Q. Zhang, X. Chen, H. Zhang, "Single-Layer MoS₂ Phototransistors," *ACS Nano.*, vol. 6, no. 1, pp. 74(7), December 2012.
- [8] S. Das, H. Y. Chen, A. V. Penumatcha, J. Appenzeller, "High Performance Multilayer MoS₂ transistors with Scandium Contacts," *Nano. Lett.*, vol. 13, no. 1, pp. 100(6), December 2012.